

PATENT

In re application of: **HIROYUKI HASEGAWA, TOMONORI YAMAOKA, YOSHIO ISHIHARA, and HIROSHI MASUSAKI**

Application No.:	New application – Div. of	Confirmation	Unassigned
	10/254,601	No:	
Filed:	October 30, 2003	Group No.:	2823
		Examiner	Estrada, Michelle
For:	SEMICONDUCTOR MANUFACTURING METHOD AND SEMICONDUCTOR MANUFACTURING APPARATUS		

APPLICATION DATA SHEET
37 C.F.R. § 1.76

1. Applicant information

First applicant: HIROYUKI HASEGAWA
Citizenship: Japanese
Residence: Tokyo, Japan

Second applicant: TOMONORI YAMAOKA
Citizenship: Japanese
Residence: Tokyo, Japan

Third applicant: YOSHIO ISHIHARA
Citizenship: Japanese
Residence: Tokyo, Japan

Fourth applicant: HIROSHI MASUSAKI
Citizenship: Japanese
Residence: Tokyo, Japan

2. Correspondence information

Correspondence for this application should be addressed as follows:

Customer No.: 00909

3. Application information

Title of Invention: SEMICONDUCTOR MANUFACTURING METHOD AND
SEMICONDUCTOR MANUFACTURING APPARATUS

Docket number assigned to this application: 061063-0306592

Suggested Classification: Class:

Subclass:

Technology Center to which subject matter is assigned: 2823

Total number of drawing sheets: 8

Type of application:

Utility

Secrecy order under § 5.2:

This application does not disclose subject matter of an application which is under a secrecy order pursuant to § 5.2.

4. Representative information

The following have a power of attorney or authorization of agent in this application:

Customer No.: 00909

5. Domestic Priority information

Domestic priority for this application is claimed as follows:

35 U.S.C. § 121:

Filed: September 26, 2002
Status: Pending
Relationship: Parent

Application No.: 10/254,601

Filed: February 27, 2001
Status: Issued
Relationship: Grandparent

Application No.: 09/793,124

6. Foreign priority information

Foreign priority is claimed for this application as follows:

Country: Japan
Application No.: 2000-052519
Filing Date: February 28, 2000
Status: Pending

Country: Japan
Application No.: 2000-108563
Filing Date: April 10, 2000
Status: Pending

7. Assignee information

The assignee(s) of this application is/are:

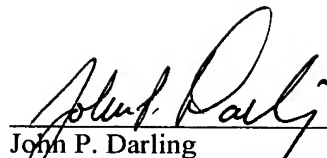
Mitsubishi Materials Silicon Corporation
5-1, Otemachi 1-chome
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Extent of interest of assignee in application: 50%

NIPPON SANSEI CORPORATION
16-7, Nishi-shinbashi 1-chome
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Extent of interest of assignee in application: 50%

Date: October 30, 2003



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